

Xencor[™] PPA LGF-1950 HS polyphthalamide

Xencor[™] PPA LGF-1950 HS is 50% long glass fiber reinforced, easy-flowing PPA which can be processed on most injection molding machines.

This material achieves extremely high mechanical and thermal properties, in combination with ease of processing and fast cycle times. It exhibits high strength, stiffness and impact strength at high temperatures; excellent creep and fatigue resistance; isotropic mechanical properties and reduced anisotropic shrinkage; high shear strength and high burst pressure; and an excellent surface finish.

- Black: Xencor™ PPA LGF-1950 HS BK 545-9
- Natural: Xencor™ PPA LGF-1950 HS NT-9

General			
Material Status	 Commercial: Active 		
Availability	 Africa & Middle East Asia Pacific Europe 	 Latin America North America	
Filler / Reinforcement	 Long Glass Fiber, 50% Filler by Weight 		
Features	 Creep Resistant Electrically Insulating Fatigue Resistant High Impact Resistance 	 High Temperature S Low CLTE Low Shrinkage Low Warpage 	tiffness
Uses	Aircraft ApplicationsAutomotive Applications	Consumer ApplicationsIndustrial Applications	
RoHS Compliance	RoHS Compliant		
Appearance	• Black	 Natural Color 	
Forms	Pellets		
Processing Method	 Compression Molding Injection Molding 	Overmolding	
Physical	Dry	Conditioned Unit	Test method
Density	1.61	g/cm³	ISO 1183
Molding Shrinkage	0.25	%	Internal Method
Water Absorption (Equilibrium, 23°C, 50% RH)	0.80	%	ISO 62

Mechanical	Dry	Conditioned Unit	Test method
Tensile Modulus			ISO 527-1
23°C	18500	18300 MPa	
90°C	16500	MPa	
120°C	10500	MPa	
Tensile Stress			ISO 527-2
Break, 23°C	275	260 MPa	
Break, 90°C	210	MPa	
Break, 120°C	135	MPa	
Tensile Strain (Break)	2.0	2.0 %	ISO 527-2
Flexural Modulus (23°C)	17500	MPa	ISO 178
Flexural Stress	410	MPa	ISO 178
Impact	Drak	Conditioned Unit	Test method
Impact Charpy Notched Impact Strength	Dry	Conditioned Unit	Test method ISO 179
-30°C	32	kJ/m²	130 179
23°C	32	kJ/m² 32 kJ/m²	
	52	52 KJ/11	ISO 179
Charpy Unnotched Impact Strength -30°C	95	kJ/m²	150 179
23°C	95	== kJ/m ² 85 kJ/m ²	
23°C	90	85 KJ/III-	
Thermal	Dry	Conditioned Unit	Test method
Deflection Temperature Under Load			
0.45 MPa, Unannealed	300	°C	ISO 75-2/B
1.8 MPa, Unannealed	285	°C	ISO 75-2/A
Thermal Conductivity	0.35	W/m/K	ISO 22007
Coefficient of Linear Thermal Expansion	2.0E-5	cm/cm/°	PC ISO 7991
Electrical	Dry	Conditioned Unit	Test method
Surface Resistivity	1.0E+13	ohms	ASTM D257
Dielectric Strength	35	kV/mm	IEC 60243-1
Comparative Tracking Index	600	V	IEC 60112
Injection		Dry Upit	
Drying Temperature	<u>Dry Unit</u> 120 °C		
Drying Time	4.0 to 8.0 hr		
Suggested Max Moisture	0.030 to 0.060 %		
Suggested Max Regrind			
	20 %		
Rear Temperature	330 to 340 °C		
Middle Temperature	340 °C		
Front Temperature	340 °C		
		335 to 345 °C	
Processing (Melt) Temp		< 345 °C	
Mold Temperature		135 to 160 °C	

Injection Notes

Pre-Drying -- Since polyamides are hygroscopic materials as well as sensitive to moisture during processing, this product should always be pre-dried.

Regrind -- Regrind of highly filled thermoplastic materials, such as this material, should only be recycled with special care. The regrind content must never exceed 20% and only regrind of optimum quality should be used. In any case, part properties should be checked.

Notes

Typical properties: these are not to be construed as specifications.

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